



Title: "Molded Flip Chip Package"

Inventors: Kumamoto et al. Application No.: 10/051,980 Attorney Docket No.: 42390P9482D
Blakely, Sokoloff, Taylor & Zafman 303-740-1980

1/4

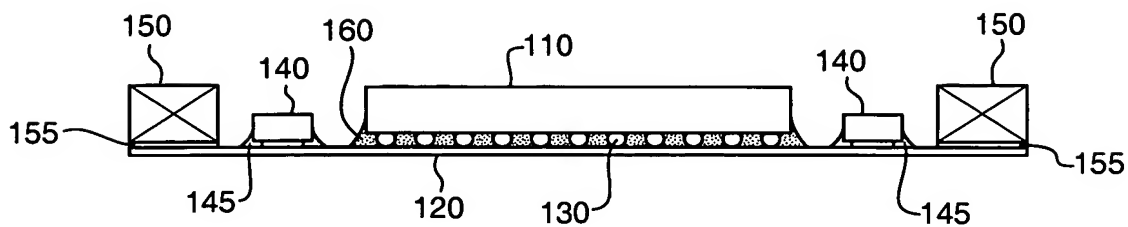


FIG. 1
PRIOR ART



Title: "Molded Flip Chip Package"

Inventors: Kumamoto et al. Application No.: 10/051,980 Attorney Docket No.: 42390P9482D
Blakely, Sokoloff, Taylor & Zafman 303-740-1980

2/4

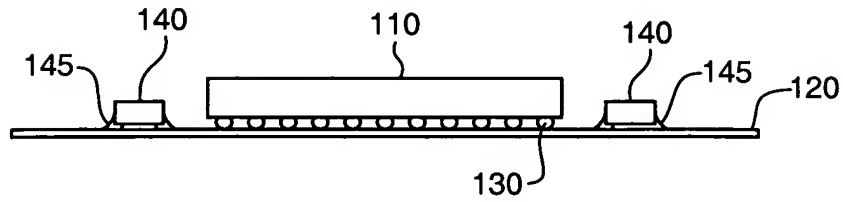


FIG. 2A

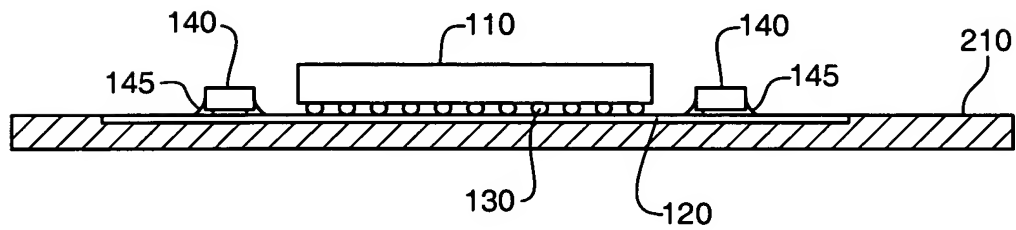


FIG. 2B

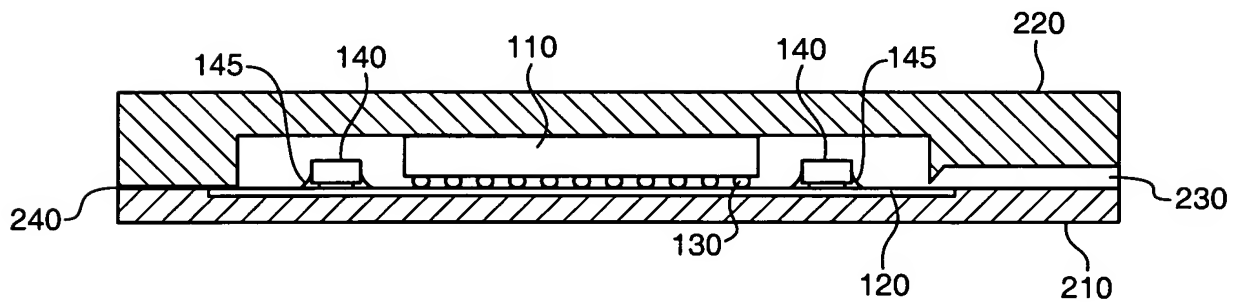


FIG. 2C



Title: "Molded Flip Chip Package"

Inventors: Kumamoto et al. Application No.: 10/051,980 Attorney Docket No.: 42390P9482D
Blakely, Sokoloff, Taylor & Zafman 303-740-1980

3/4

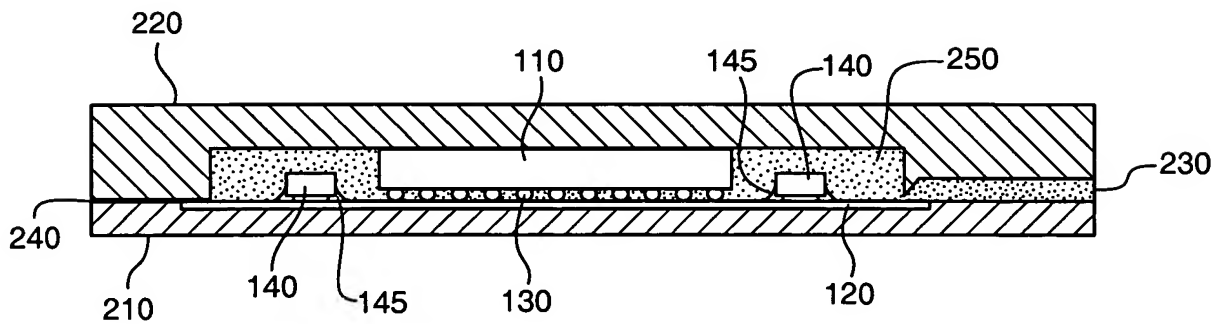


FIG. 2D

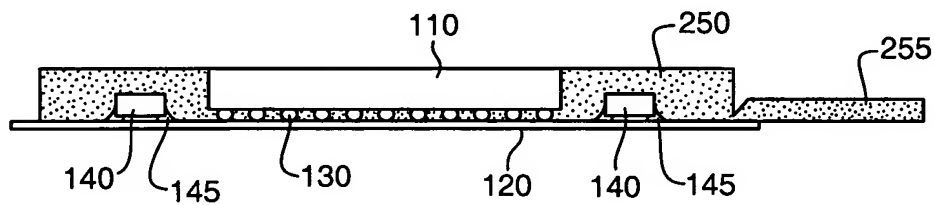


FIG. 2E

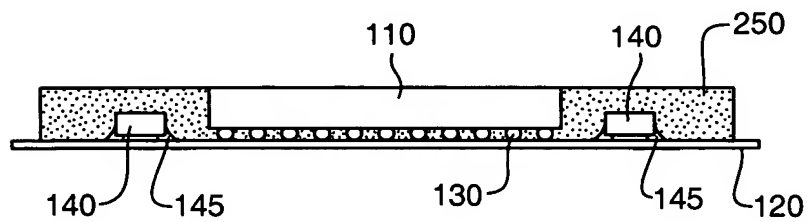


FIG. 2F



FIG. 3

